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Part Number: [87833-2420](#)

Status: **Active**

Overview: [Milli-Grid™ Connector System](#)

Description: Milli-Grid™ Header, Right Angle, Shrouded, Lead-Free, 24 Circuits, 0.38µm Gold (Au) Plating, without PCB Locator, with Locking Windows, Center Polarization Slot, Tube

Documents:

[3D Model](#)

[Drawing \(PDF\)](#)

[Product Specification PS-87831-027 \(PDF\)](#)

[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980

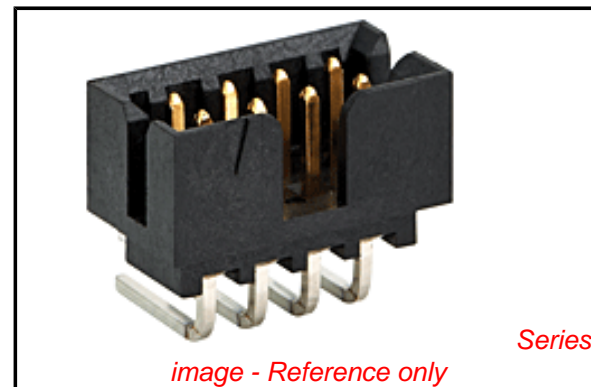
UL E29179

General

Product Family	PCB Headers
Series	87833
Application	Signal, Wire-to-Board
Comments	Contact Molex for application in automotive industry
Overview	Milli-Grid™ Connector System
Product Name	Milli-Grid™
UPC	822348271511

Physical

Breakaway	No
Circuits (Loaded)	24
Circuits (maximum)	24
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	1.255/g
Number of Rows	2
Orientation	Right Angle
PC Tail Length	2.16mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C



EU RoHS

ELV and RoHS Compliant

REACH SVHC

**Contains SVHC: No
Low-Halogen Status
Not Low-Halogen**

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[87833Series](#)

Mates With

Wire-to-Board Terminals [50394](#) , Wire-to-Board Crimp Housing [51110](#) , Wire-to-Board IDT Housings [87568](#) , Board-to-Board Top Entry Through Hole Receptacle [79107](#) , Board-to-Board FFC/FPC Top Entry Through Hole Receptacle [79108](#) , Board-to-Board Surface Mount PCB Receptacle [79109](#)

Termination Interface: Style

Through Hole

Electrical

Current - Maximum per Contact

2.0A

Voltage - Maximum

125V

Solder Process Data

Duration at Max. Process Temperature (seconds)

11

Lead-free Process Capability

SMC & Wave Capable (TH only)

Max. Cycles at Max. Process Temperature

1

Process Temperature max. C

265

Material Info

Reference - Drawing Numbers

Product Specification

PS-87831-027

Sales Drawing

SD-87833-010

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